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|  | Application Number     |                 | 10065624        |  |
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|  | First Named Inventor   | JOBS            | SON             |  |
|  | Art Unit               |                 | 3748            |  |
|  | Examiner Name          | Nguyen, Tu Minh |                 |  |
|  | Attorney Docket Number | er              | 0173.019.PCUS00 |  |

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| Examiner Name          | Nguyen, Tu Minh |                 |  |  |
| Attorney Docket Number |                 | 0173.019.PCUS00 |  |  |

|   | 1 | Office | e Action issued in JP App. No. 2001-579952; May 31, 2010. |  |  |  |  |  |
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